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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	AVR
Core Size	8-Bit
Speed	10MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	23
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-TQFP
Supplier Device Package	32-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atmega168v-10ai

Figure 6-3. Crystal Oscillator Connections

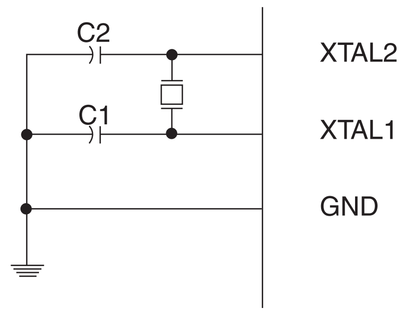


Table 6-6. Start-up Times for the Full Swing Crystal Oscillator Clock Selection

Oscillator Source / Power Conditions	Start-up Time from Power-down and Power-save	Additional Delay from Reset (V_{CC} = 5.0V)	CKSEL0	SUT1..0
Ceramic resonator, fast rising power	258 CK	14CK + 4.1 ms[1]	0	00
Ceramic resonator, slowly rising power	258 CK	14CK + 65 ms[1]	0	01
Ceramic resonator, BOD enabled	1K CK	14CK[2]	0	10
Ceramic resonator, fast rising power	1K CK	14CK + 4.1 ms[2]	0	11
Ceramic resonator, slowly rising power	1K CK	14CK + 65 ms[2]	1	00
Crystal Oscillator, BOD enabled	16K CK	14CK	1	01
Crystal Oscillator, fast rising power	16K CK	14CK + 4.1 ms	1	10
Crystal Oscillator, slowly rising power	16K CK	14CK + 65 ms	1	11

Notes:
1. These options should only be used when not operating close to the maximum frequency of the device, and only if frequency stability at start-up is not important for the application. These options are not suitable for crystals.
2. These options are intended for use with ceramic resonators and will ensure frequency stability at start-up. They can also be used with crystals when not operating close to the maximum frequency of the device, and if frequency stability at start-up is not important for the application.

Table 6-14. Clock Prescaler Select

CLKPS3	CLKPS2	CLKPS1	CLKPS0	Clock Division Factor
0	0	0	0	1
0	0	0	1	2
0	0	1	0	4
0	0	1	1	8
0	1	0	0	16
0	1	0	1	32
0	1	1	0	64
0	1	1	1	128
1	0	0	0	256
1	0	0	1	Reserved
1	0	1	0	Reserved
1	0	1	1	Reserved
1	1	0	0	Reserved
1	1	0	1	Reserved
1	1	1	0	Reserved
1	1	1	1	Reserved

```
;
0x0033RESET:   ldi    r16, high(RAMEND); Main program start
0x0034         out    SPH,r16        ; Set Stack Pointer to top of RAM
0x0035         ldi    r16, low(RAMEND)
0x0036         out    SPL,r16
0x0037         sei                   ; Enable interrupts
0x0038         <instr>  xxx
  ...    ...    ...  ...
```

When the BOOTRST Fuse is unprogrammed, the Boot section size set to 2K bytes and the IVSEL bit in the MCUCR Register is set before any interrupts are enabled, the most typical and general program setup for the Reset and Interrupt Vector Addresses in ATmega168 is:

```
Address  Labels Code                  Comments
0x0000   RESET: ldi    r16,high(RAMEND); Main program start
0x0001          out    SPH,r16        ; Set Stack Pointer to top of RAM
0x0002          ldi    r16,low(RAMEND)
0x0003          out    SPL,r16
0x0004          sei                   ; Enable interrupts
0x0005          <instr>  xxx
;
.org 0xC02
0x1C02          jmp    EXT_INT0       ; IRQ0 Handler
0x1C04          jmp    EXT_INT1       ; IRQ1 Handler
...             ...    ...            ;
0x1C32          jmp    SPM_RDY        ; Store Program Memory Ready Handler
```

When the BOOTRST Fuse is programmed and the Boot section size set to 2K bytes, the most typical and general program setup for the Reset and Interrupt Vector Addresses in ATmega168 is:

```
Address  Labels Code             Comments
.org 0x0002
0x0002          jmp    EXT_INT0       ; IRQ0 Handler
0x0004          jmp    EXT_INT1       ; IRQ1 Handler
...             ...    ...            ;
0x0032          jmp    SPM_RDY        ; Store Program Memory Ready Handler
;
.org 0x1C00
0x1C00   RESET: ldi    r16,high(RAMEND); Main program start
0x1C01          out    SPH,r16        ; Set Stack Pointer to top of RAM
0x1C02          ldi    r16,low(RAMEND)
0x1C03          out    SPL,r16
0x1C04          sei                   ; Enable interrupts
0x1C05          <instr>  xxx
```

When the BOOTRST Fuse is programmed, the Boot section size set to 2K bytes and the IVSEL bit in the MCUCR Register is set before any interrupts are enabled, the most typical and general program setup for the Reset and Interrupt Vector Addresses in ATmega168 is:

becomes the inverting output of the Oscillator amplifier. In this mode, a crystal Oscillator is connected to this pin, and the pin cannot be used as an I/O pin.

PCINT7: Pin Change Interrupt source 7. The PB7 pin can serve as an external interrupt source.

If PB7 is used as a clock pin, DDB7, PORTB7 and PINB7 will all read 0.

- **XTAL1/TOSC1/PCINT6 – Port B, Bit 6**

XTAL1: Chip clock Oscillator pin 1. Used for all chip clock sources except internal calibrated RC Oscillator. When used as a clock pin, the pin can not be used as an I/O pin.

TOSC1: Timer Oscillator pin 1. Used only if internal calibrated RC Oscillator is selected as chip clock source, and the asynchronous timer is enabled by the correct setting in ASSR. When the AS2 bit in ASSR is set (one) to enable asynchronous clocking of Timer/Counter2, pin PB6 is disconnected from the port, and becomes the input of the inverting Oscillator amplifier. In this mode, a crystal Oscillator is connected to this pin, and the pin can not be used as an I/O pin.

PCINT6: Pin Change Interrupt source 6. The PB6 pin can serve as an external interrupt source.

If PB6 is used as a clock pin, DDB6, PORTB6 and PINB6 will all read 0.

- **SCK/PCINT5 – Port B, Bit 5**

SCK: Master Clock output, Slave Clock input pin for SPI channel. When the SPI is enabled as a Slave, this pin is configured as an input regardless of the setting of DDB5. When the SPI is enabled as a Master, the data direction of this pin is controlled by DDB5. When the pin is forced by the SPI to be an input, the pull-up can still be controlled by the PORTB5 bit.

PCINT5: Pin Change Interrupt source 5. The PB5 pin can serve as an external interrupt source.

- **MISO/PCINT4 – Port B, Bit 4**

MISO: Master Data input, Slave Data output pin for SPI channel. When the SPI is enabled as a Master, this pin is configured as an input regardless of the setting of DDB4. When the SPI is enabled as a Slave, the data direction of this pin is controlled by DDB4. When the pin is forced by the SPI to be an input, the pull-up can still be controlled by the PORTB4 bit.

PCINT4: Pin Change Interrupt source 4. The PB4 pin can serve as an external interrupt source.

- **MOSI/OC2/PCINT3 – Port B, Bit 3**

MOSI: SPI Master Data output, Slave Data input for SPI channel. When the SPI is enabled as a Slave, this pin is configured as an input regardless of the setting of DDB3. When the SPI is enabled as a Master, the data direction of this pin is controlled by DDB3. When the pin is forced by the SPI to be an input, the pull-up can still be controlled by the PORTB3 bit.

OC2, Output Compare Match Output: The PB3 pin can serve as an external output for the Timer/Counter2 Compare Match. The PB3 pin has to be configured as an output (DDB3 set (one)) to serve this function. The OC2 pin is also the output pin for the PWM mode timer function.

PCINT3: Pin Change Interrupt source 3. The PB3 pin can serve as an external interrupt source.

- **$\overline{\text{SS}}$/OC1B/PCINT2 – Port B, Bit 2**

$\overline{\text{SS}}$: Slave Select input. When the SPI is enabled as a Slave, this pin is configured as an input regardless of the setting of DDB2. As a Slave, the SPI is activated when this pin is driven low.

Table 10-4. Overriding Signals for Alternate Functions in PB7..PB4

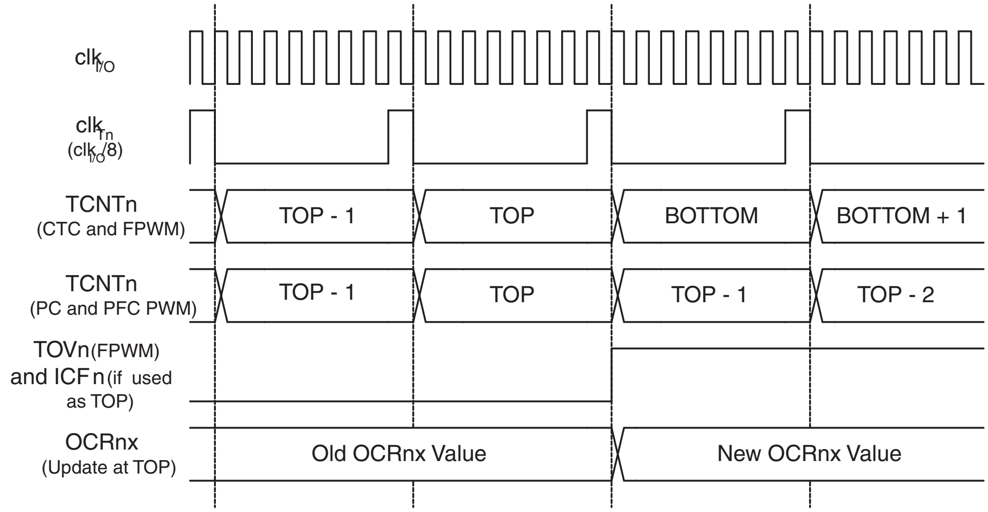
Signal Name	PB7/XTAL2/ TOSC2/PCINT7[(1)]	PB6/XTAL1/ TOSC1/PCINT6[(1)]	PB5/SCK/ PCINT5	PB4/MISO/ PCINT4
PUOE	$\overline{\text{INTRC}}$ • $\overline{\text{EXTCK}}$+ AS2	$\overline{\text{INTRC}}$ + AS2	SPE • $\overline{\text{MSTR}}$	SPE • MSTR
PUOV	0	0	PORTB5 • $\overline{\text{PUD}}$	PORTB4 • $\overline{\text{PUD}}$
DDOE	$\overline{\text{INTRC}}$ • $\overline{\text{EXTCK}}$+ AS2	$\overline{\text{INTRC}}$ + AS2	SPE • $\overline{\text{MSTR}}$	SPE • MSTR
DDOV	0	0	0	0
PVOE	0	0	SPE • MSTR	SPE • $\overline{\text{MSTR}}$
PVOV	0	0	SCK OUTPUT	SPI SLAVE OUTPUT
DIEOE	$\overline{\text{INTRC}}$ • $\overline{\text{EXTCK}}$ + AS2 + PCINT7 • PCIE0	$\overline{\text{INTRC}}$ + AS2 + PCINT6 • PCIE0	PCINT5 • PCIE0	PCINT4 • PCIE0
DIEOV	(INTRC + EXTCK) • $\overline{\text{AS2}}$	INTRC • $\overline{\text{AS2}}$	1	1
DI	PCINT7 INPUT	PCINT6 INPUT	PCINT5 INPUT SCK INPUT	PCINT4 INPUT SPI MSTR INPUT
AIO	Oscillator Output	Oscillator/Clock Input	–	–

Notes: 1. INTRC means that one of the internal RC Oscillators are selected (by the CKSEL fuses), EXTCK means that external clock is selected (by the CKSEL fuses).

Table 10-5. Overriding Signals for Alternate Functions in PB3..PB0

Signal Name	PB3/MOSI/ OC2/PCINT3	PB2/$\overline{\text{SS}}$/ OC1B/PCINT2	PB1/OC1A/ PCINT1	PB0/ICP1/ PCINT0
PUOE	SPE • $\overline{\text{MSTR}}$	SPE • $\overline{\text{MSTR}}$	0	0
PUOV	PORTB3 • $\overline{\text{PUD}}$	PORTB2 • $\overline{\text{PUD}}$	0	0
DDOE	SPE • $\overline{\text{MSTR}}$	SPE • $\overline{\text{MSTR}}$	0	0
DDOV	0	0	0	0
PVOE	SPE • MSTR + OC2A ENABLE	OC1B ENABLE	OC1A ENABLE	0
PVOV	SPI MSTR OUTPUT + OC2A	OC1B	OC1A	0
DIEOE	PCINT3 • PCIE0	PCINT2 • PCIE0	PCINT1 • PCIE0	PCINT0 • PCIE0
DIEOV	1	1	1	1
DI	PCINT3 INPUT SPI SLAVE INPUT	PCINT2 INPUT SPI $\overline{\text{SS}}$	PCINT1 INPUT	PCINT0 INPUT ICP1 INPUT
AIO	–	–	–	–

Figure 13-13. Timer/Counter Timing Diagram, with Prescaler ($f_{clk\_I/O}/8$)



15.10 Timer/Counter Prescaler

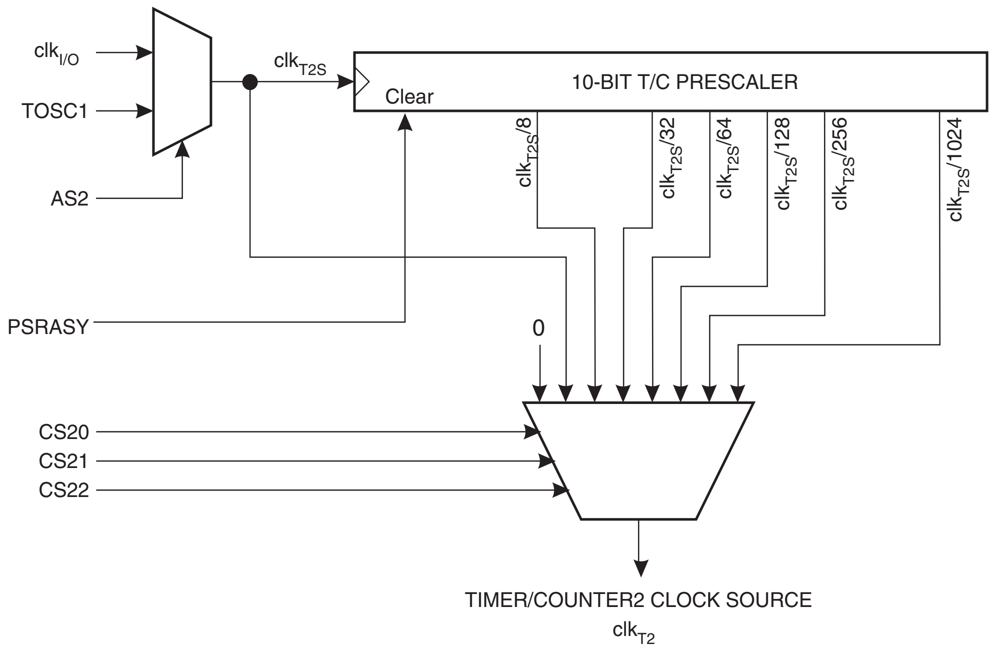


Figure 15-12. Prescaler for Timer/Counter2

The clock source for Timer/Counter2 is named clk_{T2S}. clk_{T2S} is by default connected to the main system I/O clock clk_{IO}. By setting the AS2 bit in ASSR, Timer/Counter2 is asynchronously clocked from the TOSC1 pin. This enables use of Timer/Counter2 as a Real Time Counter (RTC). When AS2 is set, pins TOSC1 and TOSC2 are disconnected from Port C. A crystal can then be connected between the TOSC1 and TOSC2 pins to serve as an independent clock source for Timer/Counter2. The Oscillator is optimized for use with a 32.768 kHz crystal. Applying an external clock source to TOSC1 is not recommended.

For Timer/Counter2, the possible prescaled selections are: $clk_{T2S}/8$, $clk_{T2S}/32$, $clk_{T2S}/64$, $clk_{T2S}/128$, $clk_{T2S}/256$, and $clk_{T2S}/1024$. Additionally, clk_{T2S} as well as 0 (stop) may be selected. Setting the PSRASY bit in GTCCR resets the prescaler. This allows the user to operate with a predictable prescaler.

15.10.1 General Timer/Counter Control Register – GTCCR

Bit	7	6	5	4	3	2	1	0	
	TSM	–	–	–	–	–	PSRASY	PSRSYNC	GTCCR
Read/Write	R/W	R	R	R	R	R	R/W	R/W	
Initial Value	0	0	0	0	0	0	0	0	

- **Bit 1 – PSRASY: Prescaler Reset Timer/Counter2**

When this bit is one, the Timer/Counter2 prescaler will be reset. This bit is normally cleared immediately by hardware. If the bit is written when Timer/Counter2 is operating in asynchronous mode, the bit will remain one until the prescaler has been reset. The bit will not be cleared by hardware if the TSM bit is set. Refer to the description of the "Bit 7 – TSM: Timer/Counter Synchronization Mode" on page 137 for a description of the Timer/Counter Synchronization mode.

17. USART0

The Universal Synchronous and Asynchronous serial Receiver and Transmitter (USART) is a highly flexible serial communication device. The main features are:

- **Full Duplex Operation (Independent Serial Receive and Transmit Registers)**
- **Asynchronous or Synchronous Operation**
- **Master or Slave Clocked Synchronous Operation**
- **High Resolution Baud Rate Generator**
- **Supports Serial Frames with 5, 6, 7, 8, or 9 Data Bits and 1 or 2 Stop Bits**
- **Odd or Even Parity Generation and Parity Check Supported by Hardware**
- **Data OverRun Detection**
- **Framing Error Detection**
- **Noise Filtering Includes False Start Bit Detection and Digital Low Pass Filter**
- **Three Separate Interrupts on TX Complete, TX Data Register Empty and RX Complete**
- **Multi-processor Communication Mode**
- **Double Speed Asynchronous Communication Mode**

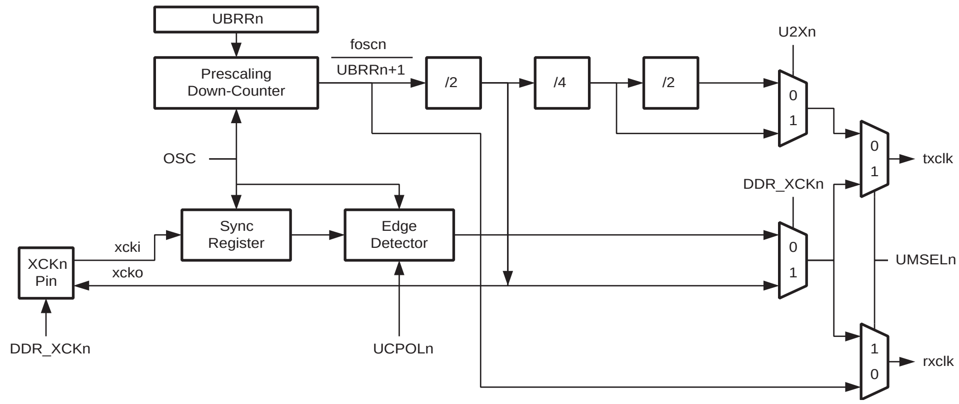
The USART can also be used in Master SPI mode, see “USART in SPI Mode” on page 196. The Power Reduction USART bit, PRUSART0, in ”Power Reduction Register - PRR” on page 40 must be disabled by writing a logical zero to it.

17.1 Overview

A simplified block diagram of the USART Transmitter is shown in Figure 17-1. CPU accessible I/O Registers and I/O pins are shown in bold.

The dashed boxes in the block diagram separate the three main parts of the USART (listed from the top): Clock Generator, Transmitter and Receiver. Control Registers are shared by all units. The Clock Generation logic consists of synchronization logic for external clock input used by synchronous slave operation, and the baud rate generator. The XCKn (Transfer Clock) pin is only used by synchronous transfer mode. The Transmitter consists of a single write buffer, a serial Shift Register, Parity Generator and Control logic for handling different serial frame formats. The write buffer allows a continuous transfer of data without any delay between frames. The Receiver is the most complex part of the USART module due to its clock and data recovery units. The recovery units are used for asynchronous data reception. In addition to the recovery units, the Receiver includes a Parity Checker, Control logic, a Shift Register and a two level receive buffer (UDRn). The Receiver supports the same frame formats as the Transmitter, and can detect Frame Error, Data OverRun and Parity Errors.

Figure 17-2. Clock Generation Logic, Block Diagram



Signal description:

txclk	Transmitter clock (Internal Signal).
rxclk	Receiver base clock (Internal Signal).
xcki	Input from XCK pin (internal Signal). Used for synchronous slave operation.
xcko	Clock output to XCK pin (Internal Signal). Used for synchronous master operation.
fosc	XTAL pin frequency (System Clock).

17.2.1 Internal Clock Generation – The Baud Rate Generator

Internal clock generation is used for the asynchronous and the synchronous master modes of operation. The description in this section refers to Figure 17-2.

The USART Baud Rate Register (UBRRn) and the down-counter connected to it function as a programmable prescaler or baud rate generator. The down-counter, running at system clock (f_{osc}), is loaded with the UBRRn value each time the counter has counted down to zero or when the UBRRnL Register is written. A clock is generated each time the counter reaches zero. This clock is the baud rate generator clock output (= f_{osc}/(UBRRn+1)). The Transmitter divides the baud rate generator clock output by 2, 8 or 16 depending on mode. The baud rate generator output is used directly by the Receiver's clock and data recovery units. However, the recovery units use a state machine that uses 2, 8 or 16 states depending on mode set by the state of the UMSELn, U2Xn and DDR_XCKn bits.

- **Bit 5 – UDRIEn: USART Data Register Empty Interrupt Enable n**

Writing this bit to one enables interrupt on the UDREn Flag. A Data Register Empty interrupt will be generated only if the UDRIEn bit is written to one, the Global Interrupt Flag in SREG is written to one and the UDREn bit in UCSRnA is set.

- **Bit 4 – RXENn: Receiver Enable n**

Writing this bit to one enables the USART Receiver. The Receiver will override normal port operation for the RxDn pin when enabled. Disabling the Receiver will flush the receive buffer invalidating the FEn, DORn, and UPEn Flags.

- **Bit 3 – TXENn: Transmitter Enable n**

Writing this bit to one enables the USART Transmitter. The Transmitter will override normal port operation for the TxDn pin when enabled. The disabling of the Transmitter (writing TXENn to zero) will not become effective until ongoing and pending transmissions are completed, i.e., when the Transmit Shift Register and Transmit Buffer Register do not contain data to be transmitted. When disabled, the Transmitter will no longer override the TxDn port.

- **Bit 2 – UCSZn2: Character Size n**

The UCSZn2 bits combined with the UCSZn1:0 bit in UCSRnC sets the number of data bits (Character SiZe) in a frame the Receiver and Transmitter use.

- **Bit 1 – RXB8n: Receive Data Bit 8 n**

RXB8n is the ninth data bit of the received character when operating with serial frames with nine data bits. Must be read before reading the low bits from UDRn.

- **Bit 0 – TXB8n: Transmit Data Bit 8 n**

TXB8n is the ninth data bit in the character to be transmitted when operating with serial frames with nine data bits. Must be written before writing the low bits to UDRn.

17.9.4 USART Control and Status Register n C – UCSRnC

Bit	7	6	5	4	3	2	1	0	
	UMSELn1	UMSELn0	UPMn1	UPMn0	USBSn	UCSZn1	UCSZn0	UCPOLn	UCSRnC
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Initial Value	0	0	0	0	0	1	1	0	

- **Bits 7:6 – UMSELn1:0 USART Mode Select**

These bits select the mode of operation of the USARTn as shown in Table 17-4.

Table 17-4. UMSELn Bits Settings

UMSELn1	UMSELn0	Mode
0	0	Asynchronous USART
0	1	Synchronous USART
1	0	(Reserved)
1	1	Master SPI (MSPIM)(1)

Note: 1. See ”USART in SPI Mode” on page 196 for full description of the Master SPI Mode (MSPIM) operation

• **Bits 5:4 – UPMn1:0: Parity Mode**

These bits enable and set type of parity generation and check. If enabled, the Transmitter will automatically generate and send the parity of the transmitted data bits within each frame. The Receiver will generate a parity value for the incoming data and compare it to the UPMn setting. If a mismatch is detected, the UPEn Flag in UCSRnA will be set.

Table 17-5. UPMn Bits Settings

UPMn1	UPMn0	Parity Mode
0	0	Disabled
0	1	Reserved
1	0	Enabled, Even Parity
1	1	Enabled, Odd Parity

• **Bit 3 – USBSn: Stop Bit Select**

This bit selects the number of stop bits to be inserted by the Transmitter. The Receiver ignores this setting.

Table 17-6. USBS Bit Settings

USBSn	Stop Bit(s)
0	1-bit
1	2-bit

• **Bit 2:1 – UCSZn1:0: Character Size**

The UCSZn1:0 bits combined with the UCSZn2 bit in UCSRnB sets the number of data bits (Character SiZe) in a frame the Receiver and Transmitter use.

Table 17-7. UCSZn Bits Settings

UCSZn2	UCSZn1	UCSZn0	Character Size
0	0	0	5-bit
0	0	1	6-bit
0	1	0	7-bit
0	1	1	8-bit
1	0	0	Reserved
1	0	1	Reserved
1	1	0	Reserved
1	1	1	9-bit

• **Bit 0 – UCPOLn: Clock Polarity**

This bit is used for synchronous mode only. Write this bit to zero when asynchronous mode is used. The UCPOLn bit sets the relationship between data output change and data input sample, and the synchronous clock (XCKn).

The upper 7 bits are the address to which the 2-wire Serial Interface will respond when addressed by a Master. If the LSB is set, the TWI will respond to the general call address (0x00), otherwise it will ignore the general call address.

TWCR	TWINT	TWEA	TWSTA	TWSTO	TWWC	TWEN	–	TWIE
value	0	1	0	0	0	1	0	X

TWEN must be written to one to enable the TWI. The TWEA bit must be written to one to enable the acknowledgement of the device's own slave address or the general call address. TWSTA and TWSTO must be written to zero.

When TWAR and TWCR have been initialized, the TWI waits until it is addressed by its own slave address (or the general call address if enabled) followed by the data direction bit. If the direction bit is "0" (write), the TWI will operate in SR mode, otherwise ST mode is entered. After its own slave address and the write bit have been received, the TWINT Flag is set and a valid status code can be read from TWSR. The status code is used to determine the appropriate software action. The appropriate action to be taken for each status code is detailed in Table 19-5. The Slave Receiver mode may also be entered if arbitration is lost while the TWI is in the Master mode (see states 0x68 and 0x78).

If the TWEA bit is reset during a transfer, the TWI will return a "Not Acknowledge" ("1") to SDA after the next received data byte. This can be used to indicate that the Slave is not able to receive any more bytes. While TWEA is zero, the TWI does not acknowledge its own slave address. However, the 2-wire Serial Bus is still monitored and address recognition may resume at any time by setting TWEA. This implies that the TWEA bit may be used to temporarily isolate the TWI from the 2-wire Serial Bus.

In all sleep modes other than Idle mode, the clock system to the TWI is turned off. If the TWEA bit is set, the interface can still acknowledge its own slave address or the general call address by using the 2-wire Serial Bus clock as a clock source. The part will then wake up from sleep and the TWI will hold the SCL clock low during the wake up and until the TWINT Flag is cleared (by writing it to one). Further data reception will be carried out as normal, with the AVR clocks running as normal. Observe that if the AVR is set up with a long start-up time, the SCL line may be held low for a long time, blocking other data transmissions.

Note that the 2-wire Serial Interface Data Register – TWDR does not reflect the last byte present on the bus when waking up from these Sleep modes.

20-2. If ACME is cleared or ADEN is set, AIN1 is applied to the negative input to the Analog Comparator.

Table 20-2. Analog Comparator Multiplexed Input

ACME	ADEN	MUX2..0	Analog Comparator Negative Input
0	x	xxx	AIN1
1	1	xxx	AIN1
1	0	000	ADC0
1	0	001	ADC1
1	0	010	ADC2
1	0	011	ADC3
1	0	100	ADC4
1	0	101	ADC5
1	0	110	ADC6
1	0	111	ADC7

20.1.1 Digital Input Disable Register 1 – DIDR1

Bit	7	6	5	4	3	2	1	0	
	–	–	–	–	–	–	AIN1D	AIN0D	DIDR1
Read/Write	R	R	R	R	R	R	R/W	R/W	
Initial Value	0	0	0	0	0	0	0	0	

- **Bit 7..2 – Res: Reserved Bits**

These bits are unused bits in the ATmega48/88/168, and will always read as zero.

- **Bit 1, 0 – AIN1D, AIN0D: AIN1, AIN0 Digital Input Disable**

When this bit is written logic one, the digital input buffer on the AIN1/0 pin is disabled. The corresponding PIN Register bit will always read as zero when this bit is set. When an analog signal is applied to the AIN1/0 pin and the digital input from this pin is not needed, this bit should be written logic one to reduce power consumption in the digital input buffer.

• **Bit 0 – SELFPRGEN: Self Programming Enable**

This bit enables the SPM instruction for the next four clock cycles. If written to one together with either RWWSRE, BLBSET, PGWRT, or PGERS, the following SPM instruction will have a special meaning, see description above. If only SELFPRGEN is written, the following SPM instruction will store the value in R1:R0 in the temporary page buffer addressed by the Z-pointer. The LSB of the Z-pointer is ignored. The SELFPRGEN bit will auto-clear upon completion of an SPM instruction, or if no SPM instruction is executed within four clock cycles. During Page Erase and Page Write, the SELFPRGEN bit remains high until the operation is completed.

Writing any other combination than “10001”, “01001”, “00101”, “00011” or “00001” in the lower five bits will have no effect.

23.1.2 EEPROM Write Prevents Writing to SPMCSR

Note that an EEPROM write operation will block all software programming to Flash. Reading the Fuses and Lock bits from software will also be prevented during the EEPROM write operation. It is recommended that the user checks the status bit (EEPE) in the EECR Register and verifies that the bit is cleared before writing to the SPMCSR Register.

23.1.3 Reading the Fuse and Lock Bits from Software

It is possible to read both the Fuse and Lock bits from software. To read the Lock bits, load the Z-pointer with 0x0001 and set the BLBSET and SELFPRGEN bits in SPMCSR. When an LPM instruction is executed within three CPU cycles after the BLBSET and SELFPRGEN bits are set in SPMCSR, the value of the Lock bits will be loaded in the destination register. The BLBSET and SELFPRGEN bits will auto-clear upon completion of reading the Lock bits or if no LPM instruction is executed within three CPU cycles or no SPM instruction is executed within four CPU cycles. When BLBSET and SELFPRGEN are cleared, LPM will work as described in the Instruction set Manual.

Bit	7	6	5	4	3	2	1	0
Rd	–	–	–	–	–	–	LB2	LB1

The algorithm for reading the Fuse Low byte is similar to the one described above for reading the Lock bits. To read the Fuse Low byte, load the Z-pointer with 0x0000 and set the BLBSET and SELFPRGEN bits in SPMCSR. When an LPM instruction is executed within three cycles after the BLBSET and SELFPRGEN bits are set in the SPMCSR, the value of the Fuse Low byte (FLB) will be loaded in the destination register as shown below.See Table 25-5 on page 282 for a detailed description and mapping of the Fuse Low byte.

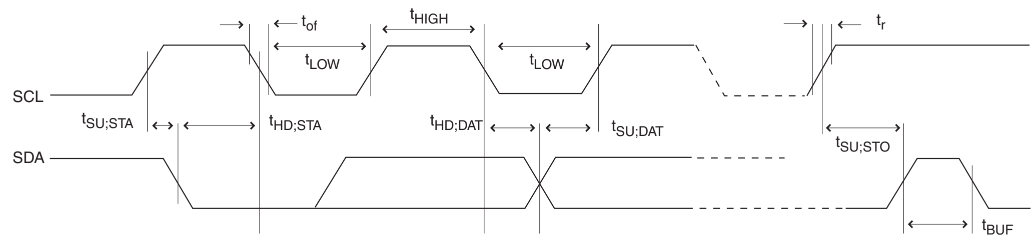
Bit	7	6	5	4	3	2	1	0
Rd	FLB7	FLB6	FLB5	FLB4	FLB3	FLB2	FLB1	FLB0

Similarly, when reading the Fuse High byte (FHB), load 0x0003 in the Z-pointer. When an LPM instruction is executed within three cycles after the BLBSET and SELFPRGEN bits are set in the SPMCSR, the value of the Fuse High byte will be loaded in the destination register as shown below. See Table 25-4 on page 281 for detailed description and mapping of the Extended Fuse byte.

Bit	7	6	5	4	3	2	1	0
Rd	FHB7	FHB6	FHB5	FHB4	FHB3	FHB2	FHB1	FHB0

Similarly, when reading the Extended Fuse byte (EFB), load 0x0002 in the Z-pointer. When an LPM instruction is executed within three cycles after the BLBSET and SELFPRGEN bits are set in the SPMCSR, the value of the Extended Fuse byte will be loaded in the destination register as

Figure 26-4. 2-wire Serial Bus Timing



26.7 SPI Timing Characteristics

See Figure 26-5 and Figure 26-6 for details.

Table 26-3. SPI Timing Parameters

	Description	Mode	Min	Typ	Max	
1	SCK period	Master		See Table 16-4		ns
2	SCK high/low	Master		50% duty cycle		
3	Rise/Fall time	Master		3.6		
4	Setup	Master		10		
5	Hold	Master		10		
6	Out to SCK	Master		$0.5 \bullet t_{sck}$		
7	SCK to out	Master		10		
8	SCK to out high	Master		10		
9	$\overline{SS}$ low to out	Slave		15		
10	SCK period	Slave	$4 \bullet t_{ck}$			
11	SCK high/low[(1)]	Slave	$2 \bullet t_{ck}$			
12	Rise/Fall time	Slave			1600	
13	Setup	Slave	10			
14	Hold	Slave	t_{ck}			
15	SCK to out	Slave		15		
16	SCK to $\overline{SS}$ high	Slave	20			
17	$\overline{SS}$ high to tri-state	Slave		10		
18	$\overline{SS}$ low to SCK	Slave	20			

Note: 1. In SPI Programming mode the minimum SCK high/low period is:
- 2 t_{CLCL} for f_{CK} < 12 MHz
- 3 t_{CLCL} for f_{CK} > 12 MHz

2. All DC Characteristics contained in this datasheet are based on simulation and characterization of other AVR microcontrollers manufactured in the same process technology. These values are preliminary values representing design targets, and will be updated after characterization of actual silicon.

Figure 27-2. Active Supply Current vs. Frequency (1 - 24 MHz)

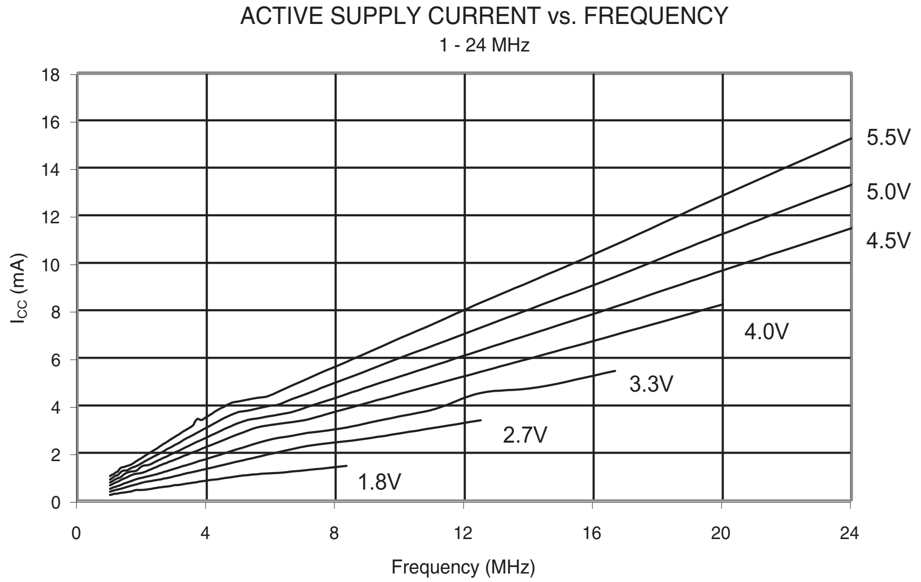


Figure 27-3. Active Supply Current vs. V_{CC} (Internal RC Oscillator, 128 kHz)

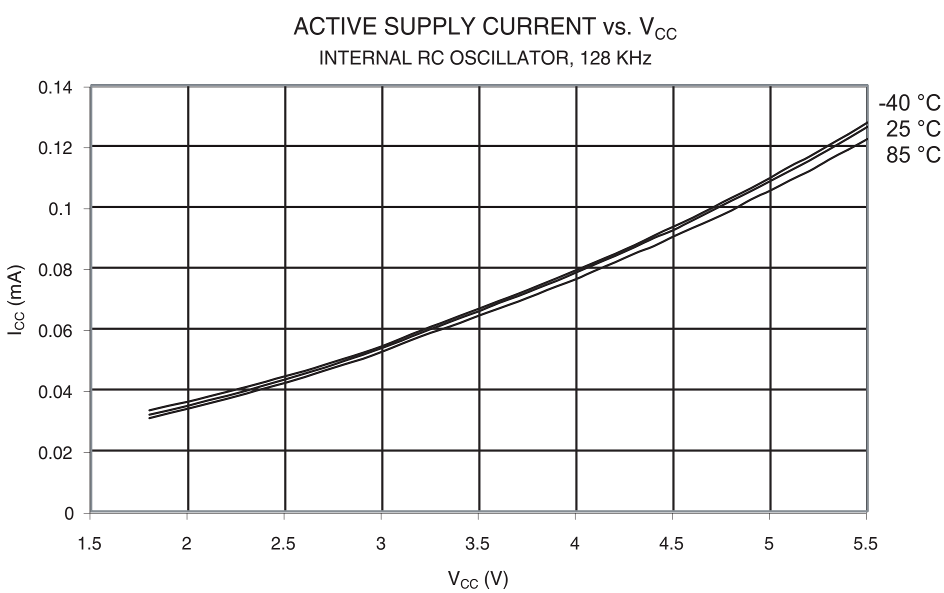
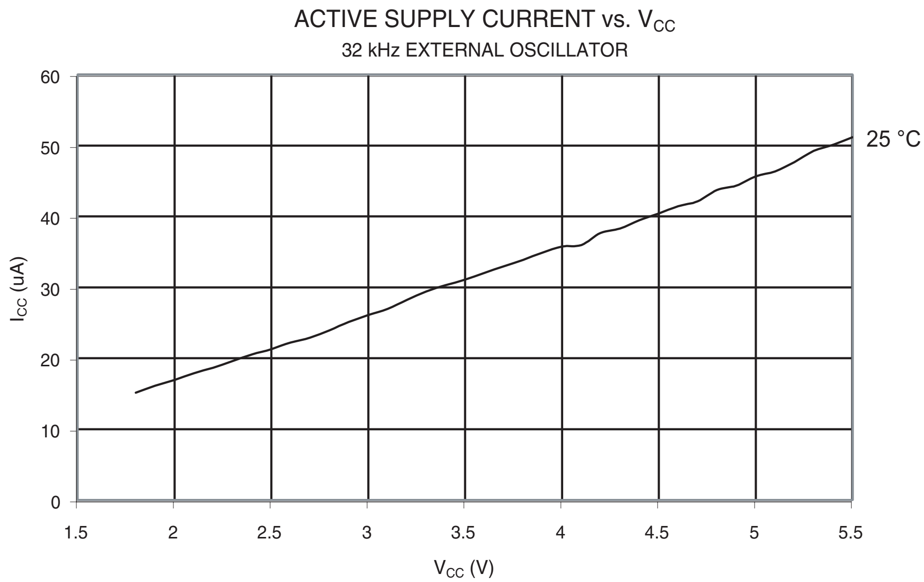
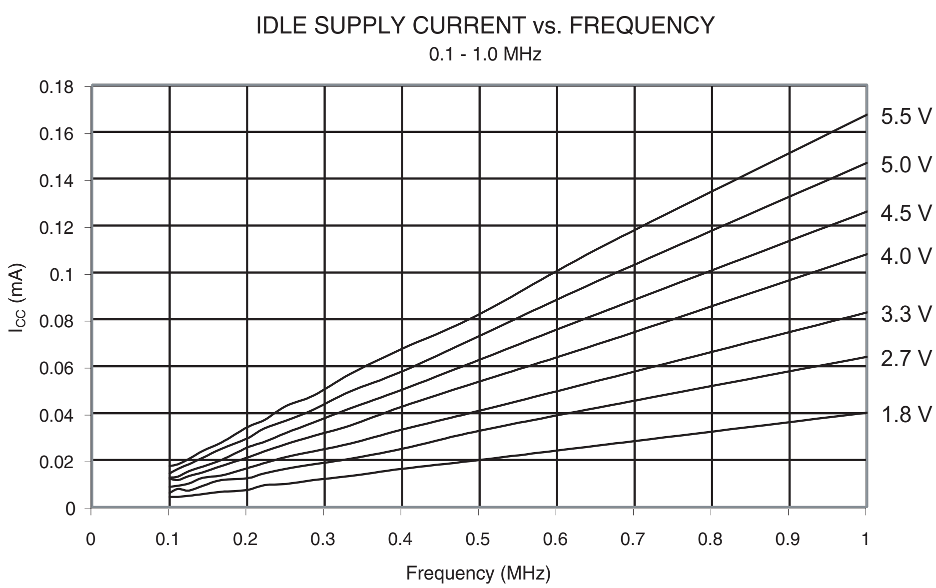


Figure 27-6. Active Supply Current vs. V_{CC} (32 kHz External Oscillator)



27.2 Idle Supply Current

Figure 27-7. Idle Supply Current vs. Frequency (0.1 - 1.0 MHz)



27.12 Current Consumption of Peripheral Units

Figure 27-43. Brownout Detector Current vs. V_{CC}

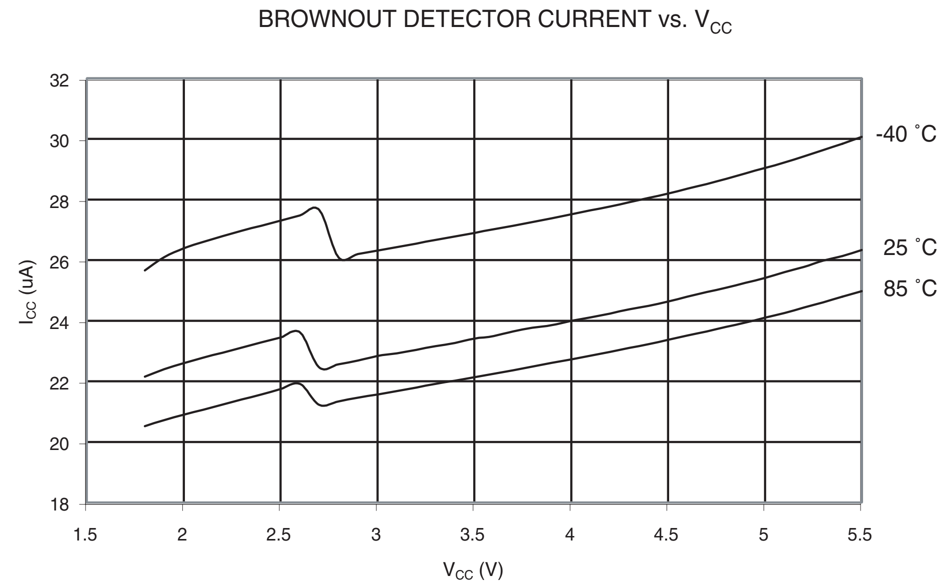


Figure 27-44. ADC Current vs. V_{CC} (ADC at 50 kHz)

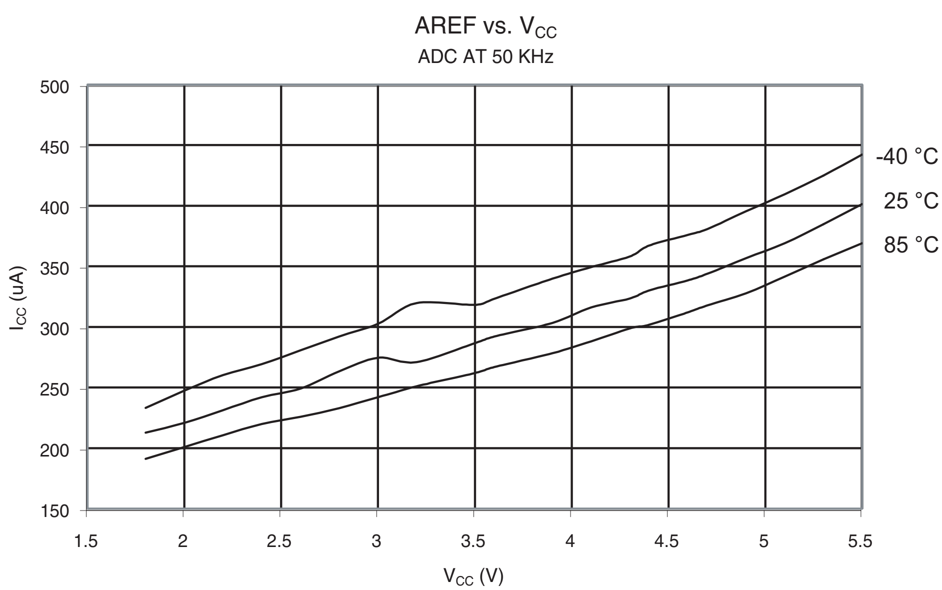


Figure 27-45. Aref Current vs. V_{CC} (ADC at 1 MHz)

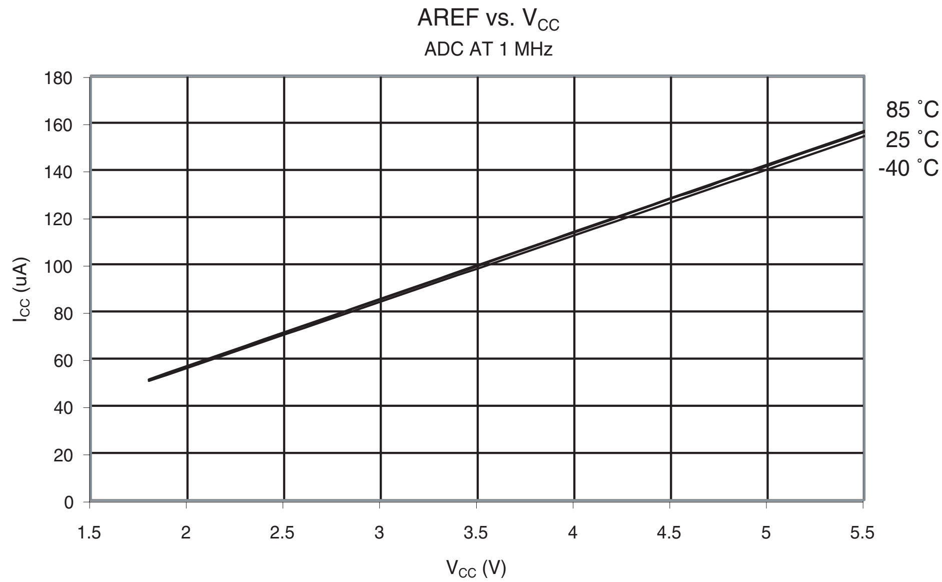
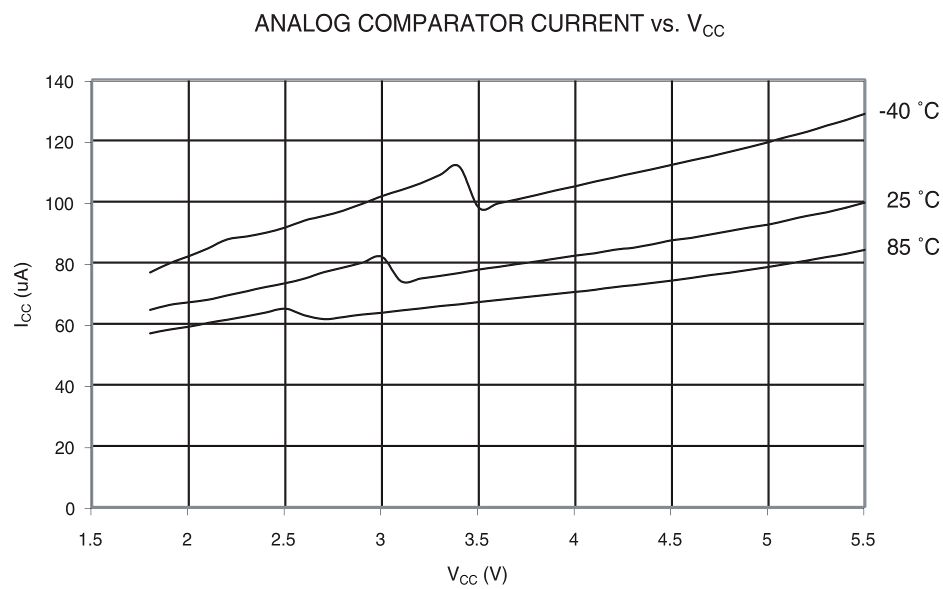


Figure 27-46. Analog Comparator Current vs. V_{CC}



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